

**IN THE SPECIFICATION:**

Please delete the first paragraph of the specification on page 1 between lines 4-9 as follows:

~~The present invention relates generally to a heat exchanger and a method of forming the heat exchanger, and particularly, a multi-fluid heat exchanger. This application is a continuation in part of co-pending application US application Ser. No 10/448,472 filed May 30, 2003 and PCT application No. PCT/US03/13254 filed on April 30, 2003 based on US patent application Ser. No. 10/140,899 filed May 7, 2002.~~